# SPECIFICATIONS FOR NICHIA CHIP TYPE WARM WHITE LED

 $\mathsf{MODEL}: NFSL036CT\text{-}H1$ 

NICHIA CORPORATION

#### 1.SPECIFICATIONS

#### (1) Absolute Maximum Ratings

 $(Ts=25^{\circ}C)$ 

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	350	mA
Pulse Forward Current	IFP	450	mA
Allowable Reverse Current	Ir	85	mA
Power Dissipation	PD	1.33	W
Operating Temperature	Topr	-40 ~ +100	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Dice Temperature	Tj	150	°C
Soldering Temperature	Tsld	Reflow Soldering: 260°C	for 10sec.
		Hand Soldering : 350°C	for 3sec.

IFP Conditions : Pulse Width  $\leq 10$ msec. and Duty  $\leq 1/10$ 

(2) Initial Electrical/Optical Characteristics

 $(Ts=25^{\circ}C)$ 

(2) Initial Electrical Spirous Characteristics							
Item	Symbol	Condition	Тур.	Max.	Unit		
Forward Voltage		VF	IF=150[mA]	(3.5)	3.8	V	
Luminous Flux		φv	I <sub>F</sub> =150[mA]	(15)	-	lm	
Chromaticity Coordinate	X	-	I <sub>F</sub> =150[mA]	0.41	-	-	
	у	-	I <sub>F</sub> =150[mA]	0.39	ı	-	
Color Rendering		Ra	I <sub>F</sub> =150[mA]	(92)	-	-	

<sup>\*</sup> Please refer to CIE 1931 chromaticity diagram.

(3) Ranking

 $(Ts=25^{\circ}C)$ 

(13.2						/
Item		Symbol	Condition	Min.	Max.	Unit
	Rank P8			18.0	21.4	
	Rank P7			15.1	18.0	
Luminous Flux	Rank P6	φv	φv I <sub>F</sub> =150[mA]	12.7	15.1	lm
	Rank P5			10.7	12.7	
	Rank P4			9.0	10.7	
Color Rendering	·	Ra	I <sub>F</sub> =150[mA]	85	-	-

<sup>\*</sup> Luminous Flux Measurement allowance is  $\pm$  7%.

Color Ranks

 $(I_F=150mA, T_S=25^{\circ}C)$ 

	Rank d1								
X	0.3575	0.3610	0.3780	0.3988	0.3897	0.3720			
у	0.3612	0.3850	0.3970	0.4116	0.3823	0.3714			
	Rank d2								
X	0.3545	0.3575	0.3720	0.3897	0.3822	0.3667			

<sup>\*</sup> Color Rendering Measurement allowance is  $\pm 5$ .

		Rank e1					
X	0.3897	0.3988	0.4162	0.4390	0.4255	0.4053	
у	0.3823	0.4116	0.4200	0.4310	0.4000	0.3907	
	•						

	Rank e2						
X	0.3822	0.3897	0.4053	0.4255	0.4129	0.3954	
у	0.3580	0.3823	0.3907	0.4000	0.3725	0.3642	

	Rank f3						
X	0.4255	0.4255					
y	0.4000	0.4310	0.4385	0.4086			

	Rank f4					
X	0.4519	0.4680	0.4970	0.4770		
у	0.4086	0.4385	0.4466	0.4137		

	Rank f5					
X	0.4129	0.4255	0.4519	0.4355		
y	0.3725	0.4000	0.4086	0.3785		

	Rank f6				
X	0.4355	0.4519	0.4770	0.4588	
y	0.3785	0.4086	0.4137	0.3838	

 $<sup>\</sup>star$  Color Coordinates Measurement allowance is  $\pm$  0.01.

The percentage of each rank in the shipment shall be determined by Nichia.

Correspondence table of Color Coordinates – Luminous Flux ranks

Ranking by Luminous Flux Ranking by Color Coordinates	P4	P5	P6	P7	P8
d1, d2, e1, e2					
f3, f4, f5, f6					

<sup>\*</sup> Shaded ranks are available.

#### 2.INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to "CHARACTERISTICS" on the following pages.

#### 3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to "OUTLINE DIMENSIONS" on the following page

Material as follows; Package : Ceramics

Encapsulating Resin : Silicone Resin (with Diffused + Phosphor)

Electrodes : Au Plating

#### 4.PACKAGING

· The LEDs are packed in cardboard boxes after taping.

Please refer to "TAPING DIMENSIONS" and "PACKING" on the following pages.

The label on the minimum packing unit shows; Part Number, Lot Number, Ranking, Quantity

- · In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- The boxes are not water resistant and therefore must be kept away from water and moisture.
- · When the LEDs are transported, we recommend that you use the same packing method as Nichia.

<sup>\*</sup> Basically, a shipment shall consist of the LEDs of a combination of the above ranks.

#### 5.LOT NUMBER

The first six digits number shows **lot number**.

The lot number is composed of the following characters;

$$\bigcirc \square \times \times \times \times - \triangle \blacksquare$$

O - Year (7 for 2007, 8 for 2008)

□ - Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)

×××× - Nichia's Product Number

 $\triangle$  - Ranking by Color Coordinates

Ranking by Luminous Flux

#### **6.RELIABILITY**

### (1) TEST ITEMS AND RESULTS

Test Item		Standard			Number of
Soldering Heat (Reflow Soldering)   Solderability   JEITA ED-4701   Tsld=215±5°C, 3sec.   1 time   0/22					
Reflow Soldering   Solderability   JEITA ED-4701   Tsld=215 ± 5°C, 3sec.   1 time   0/22				2 times	0/22
Solderability (Reflow Soldering)   A00 303   C(Lead Solder)   A0°C		300 301	(Pre treatment 30°C,70%,168hrs.)		
Reflow Soldering   300 303   (Lead Solder)   over 95%					
Thermal Shock	-	JEITA ED-4701	Tsld= $215 \pm 5$ °C, 3sec.	1 time	0/22
Temperature Cycle   JETTA ED-4701   100 C ~ 25°C ~ 100°C ~ 25°C   100 cycles   0/50   30min. 5min. 30min.	(Reflow Soldering)	300 303		over 95%	
CPTe treatment 30°C,70%,168hrs.)   Temperature Cycle   JEITA ED-4701   -40°C ~ 25°C ~ 100°C ~ 25°C   100 cycles   0/50   30min. 5min. 30min. 5min. 30min. 5min.   100 cycles   200 203   90%RH   24hrs./1cycle   1000 hrs.   0/50   200 201   200 202   200 200	Thermal Shock	JEITA ED-4701	-40°C ~ 100°C	100 cycles	0/50
Temperature Cycle         JEITA ED-4701 100 105 $-40^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim 100^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 100 cycles         0/50           Moisture Resistance Cyclic 200 203         JEITA ED-4701 200 203         25°C ~ 65°C ~ -10°C 90%RH 24hrs/1cycle         10 cycles         0/50           High Temperature Storage         JEITA ED-4701 200 201         Ta=100°C         1000 hrs.         0/50           Temperature Humidity         JEITA ED-4701 200 201         Ta=60°C, RH=90%         1000 hrs.         0/50           Storage         100 103         Ta=-40°C         1000 hrs.         0/50           Steady State Operating Life of High Temperature         Ta=25°C, IF=350mA 7 200 202         1000 hrs.         0/50           Steady State Operating Life of High Humidity Heat         Ta=100°C, IF=140mA 7 200 200 200         1000 hrs.         0/50           Steady State Operating Life of Low Temperature         60°C, RH=90%, IF=250mA 7 200 200 200         500 hrs.         0/50           Steady State Operating Life of Low Temperature         Ta=-40°C, IF=150mA 7 200 200 200 200 200 200 200 200 200 2		300 307	1min. (10sec.) 1min.		
Moisture Resistance Cyclic   JEITA ED-4701   25°C ~ 65°C ~ -10°C   10 cycles   0/50   90%RH   24hrs./1cycle   1000 hrs.   0/50   200 201   200 201   1000 hrs.   0/50   1000 hrs.   0/50   200 201   1000 hrs.   0/50   100			(Pre treatment 30°C,70%,168hrs.)		
Moisture Resistance CyclicJEITA ED-4701 200 203 $25^{\circ}\text{C} \sim 65^{\circ}\text{C} \sim -10^{\circ}\text{C}$ 90%RH 24hrs/1cycle10 cycles0/50High Temperature StorageJEITA ED-4701 200 201 $Ta=100^{\circ}\text{C}$ $1000 \text{ hrs.}$ 0/50Temperature Humidity StorageJEITA ED-4701 100 103 $Ta=60^{\circ}\text{C}$ , RH=90% $1000 \text{ hrs.}$ 0/50Low Temperature StorageJEITA ED-4701 200 202 $Ta=-40^{\circ}\text{C}$ $1000 \text{ hrs.}$ 0/50Steady State Operating Life of High Temperature $Ta=100^{\circ}\text{C}$ , IF=350mA Tested with Nichia standard circuit board.* $1000 \text{ hrs.}$ 0/50Steady State Operating Life of High Humidity Heat $60^{\circ}\text{C}$ , RH=90%, IF=250mA Tested with Nichia standard circuit board.* $500 \text{ hrs.}$ 0/50Steady State Operating Life of Low Temperature $Ta=-40^{\circ}\text{C}$ , IF=150mA Tested with Nichia standard circuit board.* $1000 \text{ hrs.}$ 0/50Permanence of MarkingJEITA ED-4701 500 501Solvent Temperature : $20 \sim 25^{\circ}\text{C}$ Dipping Time : $5 \text{ min.}$ $1000 \text{ hrs.}$ 0/22VibrationJEITA ED-4701 400 403 $1000 \sim 2000 \sim 100 \text{Hz}$ Sweep 4min. 200m/s² 3 directions, 4cycles $48 \text{min.}$ 200p/s20/10Electrostatic DischargesJEITA ED-4701 400 403 $1000 \sim 2000 \sim 100 \text{ Hz}$ 3 times $3 \text{ times}$ 0/22	Temperature Cycle	JEITA ED-4701	-40°C ~ 25°C ~ 100°C ~ 25°C	100 cycles	0/50
High Temperature Storage   JEITA ED-4701   Ta=100°C   1000 hrs.   0/50		100 105	30min. 5min. 30min. 5min.		
High Temperature StorageJEITA ED-4701 200 201 $Ta=100^{\circ}C$ 1000 hrs.0/50Temperature Humidity StorageJEITA ED-4701 100 103 $Ta=60^{\circ}C$ , RH=90%1000 hrs.0/50Low Temperature StorageJEITA ED-4701 200 202 $Ta=-40^{\circ}C$ 1000 hrs.0/50Steady State Operating Life of High Temperature $Ta=25^{\circ}C$ , IF=350mA Tested with Nichia standard circuit board.*1000 hrs.0/50Steady State Operating Life of High Humidity Heat $Ta=100^{\circ}C$ , IF=140mA Tested with Nichia standard circuit board.*1000 hrs.0/50Steady State Operating Life of High Humidity Heat $60^{\circ}C$ , RH=90%, IF=250mA Tested with Nichia standard circuit board.*500 hrs.0/50Steady State Operating Life of Low Temperature $Ta=-40^{\circ}C$ , IF=150mA Tested with Nichia standard circuit board.*1000 hrs.0/50Permanence of MarkingJEITA ED-4701 Solvent : Isopropyl Alcohol Dipping Time : 5 min.1 time0/22VibrationJEITA ED-4701 400 403100 ~ 2000 ~ 100Hz Sweep 4min. 200m/s² 3 directions, 4cycles48min.0/10Electrostatic DischargesJEITA ED-4701 400 403R=1.5k $\Omega$ , C=100pF3 times0/22	Moisture Resistance Cyclic	JEITA ED-4701	25°C ~ 65°C ~ -10°C	10 cycles	0/50
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			•		
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, 1	Electrostatic Discharges	JEITA ED-4701	-	3 times	0/22
300 304 Test Voltage=2kV Negative/Positive			<u> </u>		J. 22

<sup>\*</sup> Thermal resistance of LED with Nichia standard circuit board: Rja = 90°C/W Nichia standard circuit board: FR4, t=1.6mm, Copper foil, t=0.07mm

#### (2) CRITERIA FOR JUDGING DAMAGE

			Criteria for Judgement		
Item	Symbol	Test Conditions	Min.	Max.	
Forward Voltage	VF	I <sub>F</sub> =150mA	-	Initial Level $\times$ 1.1	
Luminous Flux	φv	I <sub>F</sub> =150mA	Initial Level $\times$ 0.7	-	

<sup>\*</sup> The test is performed after the board is cooled down to the room temperature.

#### 7.CAUTIONS

The LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of the LEDs is changed a little by an operating current. Care should be taken after due consideration when using LEDs.

#### (1) Moisture Proof Package

- · When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.
- The moisture proof package is made of an aluminum moisture proof bag. A package of a moisture absorbent material (silica gel) is inserted into the aluminium moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

### (2) Storage

· Storage Conditions

Before opening the package:

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

#### After opening the package:

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in the moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

· If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition.

Baking treatment : more than 24 hours at  $65 \pm 5^{\circ}$ C

- · Nichia LED electrodes are gold plated. The gold surface may be affected by environments which contain corrosive substances. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.
- · Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

#### (3) Static Electricity

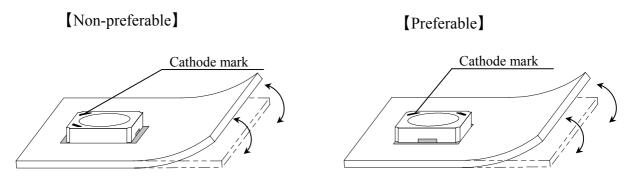
- · Static electricity or surge voltage damages the LEDs.

  It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- · All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
- · When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- · Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria: (VF > 2.0V at IF=0.5mA)

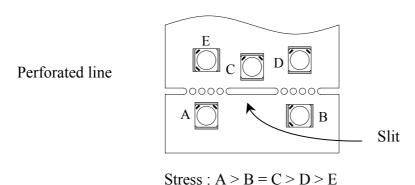
#### (4) LED position and orientation

· Warpage of circuit board with soldered LEDs may result in damage or package breakage of the LEDs. Please pay special attention to the orientation of the LEDs as to avoid LED failure caused by bow, twist and warpage of the board.



When mechanical stress from the board affects the soldered LED, place the LED in the preferable location and orientation as shown above.

· Depending on the position and direction of LED, the mechanical stress on the LED package can be changed. Refer to the following figure.



- · When separating the circuit boards with soldered LEDs, please use appropriate tools and equipment. Hand brake without these tools and equipment may not be used.
- The use of aluminum substrate increases stress to solder joints due to thermal expansion of substrate and subsequently may result in solder joint crack. Users may need to evaluate their specific application to determine any impact due to the use of aluminum substrate.

#### (5) Soldering Conditions

• The LEDs can be soldered in place using the reflow soldering method. Nichia cannot make a guarantee on the LEDs after they have been assembled using the dip soldering method.

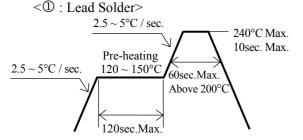
· Recommended soldering conditions

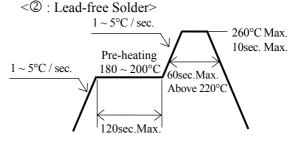
Reflow Soldering			Hand Soldering	
	Lead Solder	Lead-free Solder		
Pre-heat	120 ∼ 150°C	180 ~ 200°C	Temperature	350°C Max.
Pre-heat time	120 sec. Max.	120 sec. Max.	Soldering time	3 sec. Max.
Peak	240°C Max.	260°C Max.		(one time only)
temperature				
Soldering time	10 sec. Max.	10 sec. Max.		
Condition	refer to	refer to		
	Temperature - profile ①.	Temperature - profile ②.		
		$(N_2 \text{ reflow is recommended.})$		

- \* Although the recommended soldering conditions are specified in the above table, reflow or hand soldering at the lowest possible temperature is desirable for the LEDs.
- \* A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

[Temperature-profile (Surface of circuit board)]

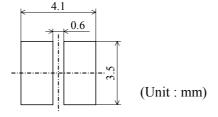
Use the conditions shown to the under figure.





[Recommended soldering pad design]

Use the following conditions shown in the figure.



- · Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the chip mounter, the picking up nozzle that does not affect the silicone resin should be used.
- · Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- · Reflow soldering should not be done more than two times.
- · When soldering, do not put stress on the LEDs during heating.

#### (6) Cleaning

- · It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- · Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

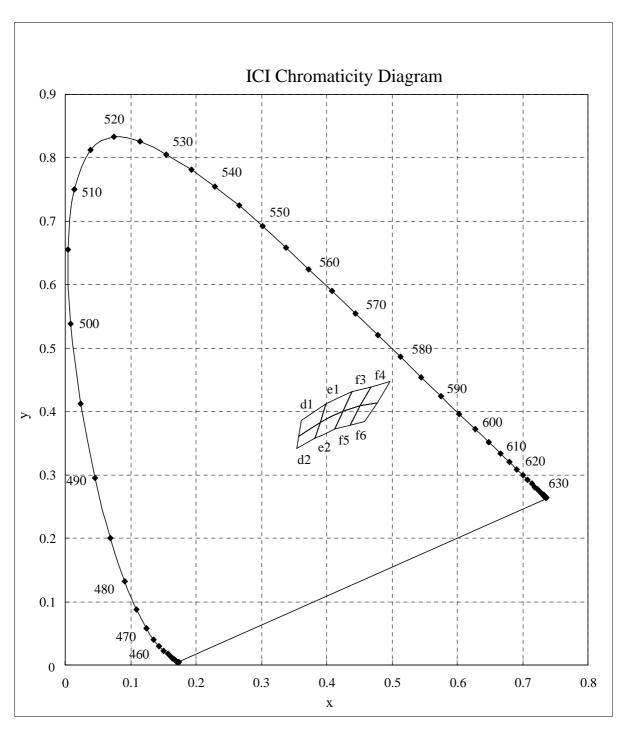
#### (7) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- · Please determine the operating current with consideration of the ambient temperature local to the LED and refer to the plot of Ambient temperature vs. Allowable Forward Current on CHARACTERISTICS in this specifications. Please also take measures to remove heat from the area near the LED to improve the operational characteristics of the LED.
- The equation ① indicates correlation between Tj and Ta, and the equation ② indicates correlation between Tj and Ts.

```
Tj=Ta+Rja\cdot W ....... ① Tj=Ts+Rjs\cdot W ......... ② *Tj=Dice Temperature: °C, Ta=Ambient Temperature: °C, Ts=Solder Temperature (Cathode Side): °C, Rja=Heat resistance from Dice to Ambient temperature: °C/W, Rjs=Heat resistance from Dice to Ts measuring point = 40°C/W, = Inputting Power (= Inputting Power
```

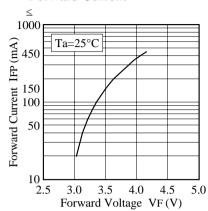
#### (8) Others

- · NFSL036C-H1 complies with RoHS Directive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
- · Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- · User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
- The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specifications of the product may be modified for improvement without notice.

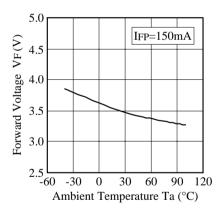


\* Color Coordinates Measurement allowance is  $\pm 0.01$ .

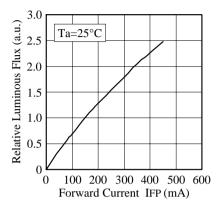
### ■ Forward Voltage vs. Forward Current



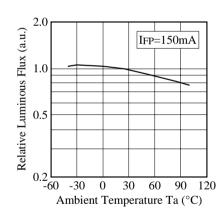
# ■ Ambient Temperature vs. Forward Voltage



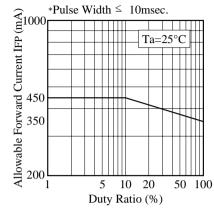
■ Forward Current vs. Relative Luminous Flux



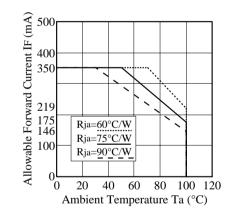
■ Ambient Temperature vs. Relative Luminous Flux



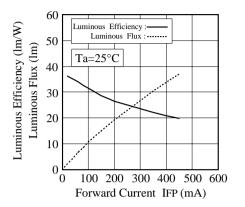
# Duty Ratio vs.Allowable Forward Current



Ambient Temperature vs.
 Allowable Forward Current



### ■ Forward Current vs. Luminous Efficiency

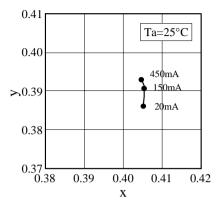




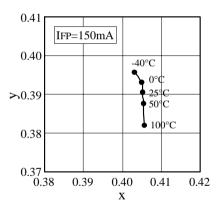
	Model	NFSL036C-H1	$\setminus$
1	Title	CHARACTERISTICS	
	No.	080205809311	

Nichia STS-DA1-0106 <Cat.No.080220>

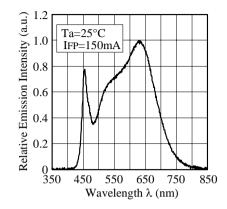
# ■ Forward Current vs. Chromaticity Coordinate



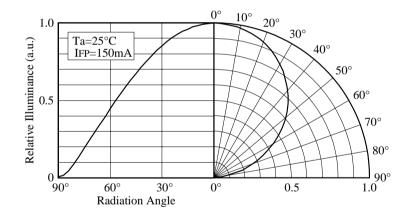
# ■ Ambient Temperature vs. Chromaticity Coordinate



### ■ Spectrum

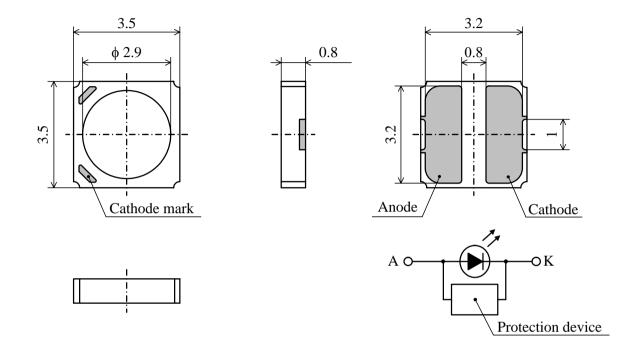


### ■ Directivity



	Model	NFSL036C-H1	$\setminus$
NICHIA CORPORATION	Title	CHARACTERISTICS	
	No.	080205809321	

Nichia STS-DA1-0106 <Cat.No.080220>



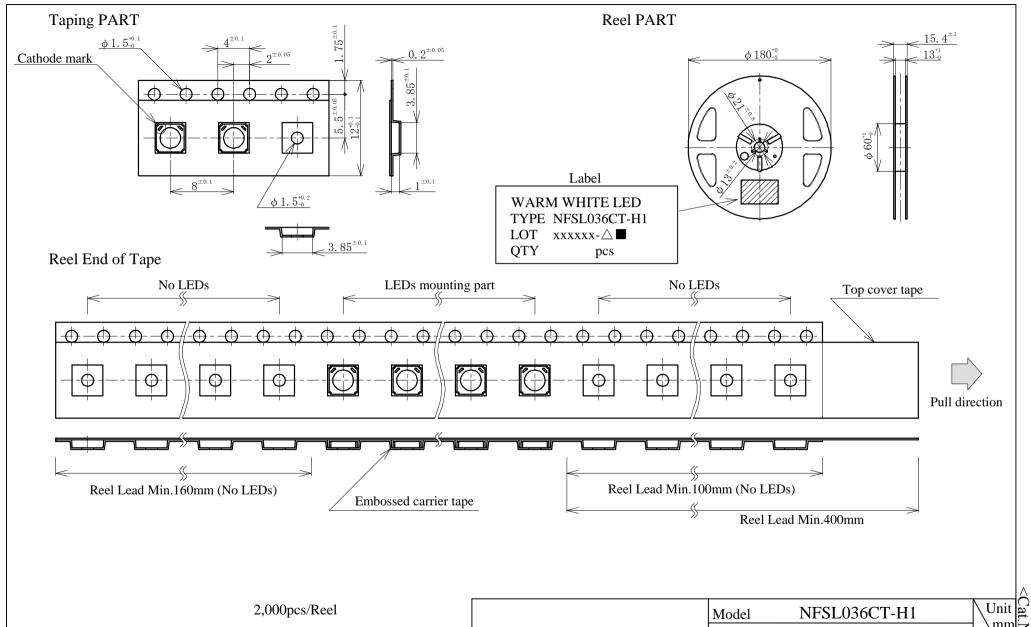
ITEM	MATERIALS		
PACKAGE	Ceramics		
ENCAPSULATING RESIN	Silicone Resin (with Diffused + Phosphor)		
ELECTRODES	Au Plating		

\* NFSL036C-H1 has a protection device built in as a protection circuit against static electricity.

			Nichia
	Model	NFSL036C-H1	Unit at S
NICHIA CORPORATION	Title	OUTLINE DIMENSIONS	8/1 No.080 Scale 00.080
	No.	080205809441	Allow 50 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6

Taping is based on the JIS C 0806: Packaging of Electronic

Components on Continuous Tapes.



Title

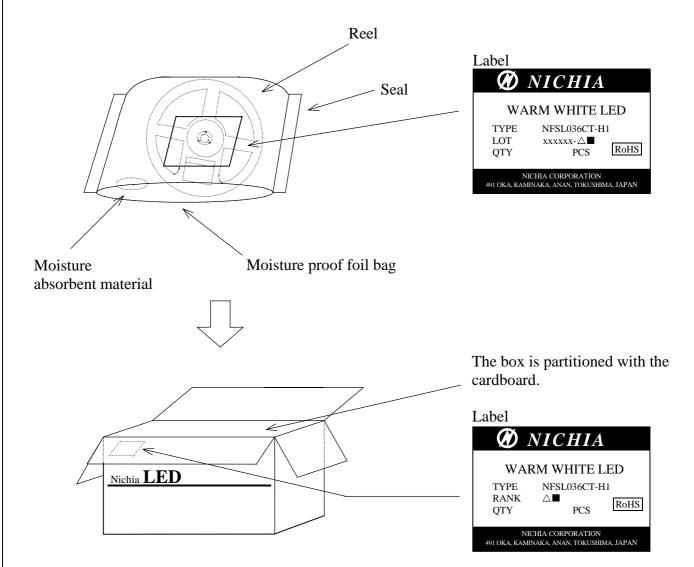
No.

NICHIA CORPORATION

TAPING DIMENSIONS

080207809451

Nichia STS-DA1-0106 <Cat.No.080220> The reel and moisture absorbent material are put in the moisture proof foil bag and then heat sealed.



Packing unit

	Reel/bag	Quantity/bag (pcs)
Moisture proof foil bag	1reel	2,000 MAX.

Cardboard box	Dimensions (mm)	Reel/box	Quantity/box (pcs)
Cardboard box S	291×237×120×8t	5reel MAX.	10,000 MAX.
Cardboard box M	259×247×243×5t	10reel MAX.	20,000 MAX.
Cardboard box L	444×262×259×8t	20reel MAX.	40,000 MAX.

	Model	NFSL036CT-H1	
NICHIA CORPORATION	Title	PACKING	
	No.	080207809461	